

AMENDMENT TO THE CLAIMS:

This listing of claims will replace all prior versions of claims in the application:

LISTING OF CLAIMS:

1. (CURRENTLY AMENDED) A non-volatile memory device, comprising:
 - a memory cell; and
 - a plurality of sub-cells included in the memory cell and each sub-cell including at least one magneto resistive element, the magneto resistive elements in each sub-cell being connected in parallel;wherein the sub-cells are electrically connected.
2. (ORIGINAL) A memory device as in claim 1 wherein the sub-cells are connected in series.
3. (CURRENTLY AMENDED) A non-volatile memory device as recited in claim 1, comprising a memory cell; and a plurality of sub-cells included in the memory cell and including at least one magneto resistive element; wherein the sub-cells are connected in electrically connected in parallel.
4. (ORIGINAL) A memory device as recited in claim 1 further comprising a transistor electrically connected with the magneto resistive element.
5. (CURRENTLY AMENDED) The A non-volatile memory device according to Claim 1, comprising a memory cell; and a plurality of sub-cells included in the memory cell and including at least one magneto resistive element; wherein the sub-cells are electrically connected; wherein the sub-cell is composed of a plurality of sub-cells comprising a plurality of magneto resistive elements connected in parallel and one

selection transistor connected with the magneto resistive elements and wherein the sub-cells are connected in series.

6. (CURRENTLY AMENDED) ~~The A non-volatile memory device according to Claim 1, comprising a memory cell; and a plurality of sub-cells included in the memory cell and including at least one magneto resistive element; wherein the sub-cells are electrically connected; wherein at least one sub-cell comprises a plurality of magneto resistive elements connected in series and one selection transistor, and wherein the memory cell comprises a plurality of sub-cells connected in parallel.~~

7. (CURRENTLY AMENDED) ~~The A non-volatile memory device according to Claim 1, comprising a memory cell; and a plurality of sub-cells included in the memory cell and including at least one magneto resistive element; wherein the sub-cells are electrically connected; wherein the sub-cell is composed of one magneto resistive element and one selection transistor, and wherein the memory cell comprises n2 parallel sub-cells connected in series (n2 is at least 2), the parallel sub-cell comprising the n1 sub-cells connected in parallel (n1 is at least 2).~~

8. (ORIGINAL) A non-volatile memory device, comprising:
a memory cell, the memory cell further comprising:
 a plurality of sub-cells connected in series; and
 one selection transistor electrically connected with at least
 one of the sub-cells;
 wherein the sub-cell comprises a plurality of magneto resistive
 elements connected in parallel with one another.

9. (ORIGINAL) The non-volatile memory device according to claim 1,
wherein the number of sub-cells in a memory cell equals the number of magneto
resistive elements in a sub-cell.

10. (CURRENTLY AMENDED) The A non-volatile memory device according to Claim 1, comprising a memory cell; and a plurality of sub-cells included in the memory cell and including at least one magneto resistive element; wherein the sub-cells are electrically connected; wherein the each mangetoresistive element includes a magnetically magnetically free layer and wherein writing of information into the memory cell is performed by magnetizing into the same direction the free layers of the magneto resistive elements included in the memory cell, and wherein the reading of the information recorded in the memory cell is performed by detecting the resistance value of the whole memory cell.

11. (WITHDRAWN) A non-volatile memory device, comprising:
a plurality of memory cells comprising a magneto resistive element and a selection transistor;
wherein the memory cells are arranged into a two dimensional array;
a first interconnect line extending in a first direction of the memory array and functioning as a gate electrode of a selection transistor included in the memory cell;
a second interconnect line extending in a second direction of the memory array and connected to one end of the memory cell;
a third interconnect line extending in the second direction and connected to the other end of the memory cell;
where a circuit having the ends of the second and third interconnect lines as its terminals in a circuit region in the periphery of the memory array is connected in series with a circuit for another memory cell adjacent thereto in the first direction.

12. (WITHDRAWN) The non-volatile memory device according to Claim 11, wherein the writing of one bit of information into the non-volatile memory device is performed by magnetizing into the same direction the free layers of the magneto resistive elements of a plurality of the memory cells which are formed at the positions of

intersection of a plurality of the first interconnect lines and a plurality of the second interconnect lines, and wherein the reading of one bit of information from the non-volatile memory device is performed by inputting the same read control signal to the plurality of the first interconnect lines and detecting the resistance value between the second interconnection line and the third interconnection line of the circuits connected in series.

13. (WITHDRAWN) The non-volatile memory device according to Claim 12, wherein the number of the plurality of the first interconnect lines is the same as the number of the circuits connected in series.

14. (CURRENTLY AMENDED) A memory device, comprising:
a plurality of electrically connected memory cells, each memory cell comprising:
a plurality of sub-cells electrically connected with one another, each sub cell
further comprising:

a magnetoresistive device including at least one magneto resistive element, the magneto resistive elements in each sub-cell being connected in parallel, and

a transistor electrically connected with the magnetoresistive device.

15. (CURRENTLY AMENDED) A memory device ~~as recited in claim 14,~~
~~further comprising:~~
a plurality of electrically connected memory cells, each memory cell comprising:
a plurality of sub-cells electrically connected with one another, each sub cell
further comprising:
 a magnetoresistive device, and
 a transistor electrically connected with the magnetoresistive device; and
 a sub-cell including a plurality of magnetoresistive devices ~~connected~~ connected
 in parallel with one another.

16. (NEW) The non-volatile memory device according to claim 1, wherein writing information to the memory cell is performed by magnetizing free layers of all magneto resistive elements in the memory cell into a same direction.

17. (NEW) The non-volatile memory device according to claim 1, wherein reading information stored in the memory cell is performed by detecting a resistance value of the whole memory cell.